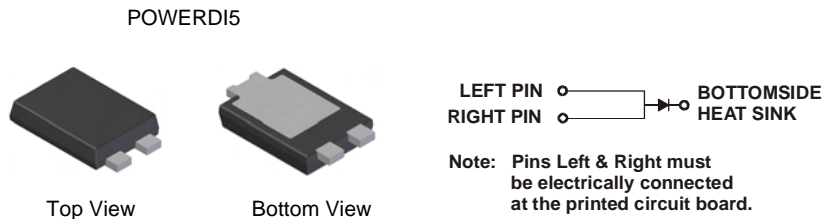


Features

- Designed as Bypass Diodes for Solar Panels
- Selectively Rated for 200°C Maximum Junction Temperature for High Thermal Reliability
- Patented Super Barrier Rectifier Technology
- Low Forward Voltage Drop
- Excellent High Temperature Stability
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: POWERDI5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 ③
- Weight: 0.093 grams (approximate)

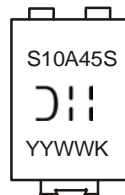


Ordering Information (Note 4)

Part Number	Case	Packaging
SBR10A45SP5-13	POWERDI5	5000/Tape & Reel
SBR10A45SP5-7	POWERDI5	1500/Tape & Reel
SBR10A45SP5Q-13	POWERDI5	5000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com>.

Marking Information



- S10A45S = Product Type Marking Code
- ⌋⌋⌋ = Manufacturers' code marking
- K = Factory designator
- YYWW = Date Code Marking
- YY = Last two digits of year (ex: 08 for 2008)
- WW = Week code (01 - 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _R RM	45	V
Working Peak Reverse Voltage	V _R WM		
DC Blocking Voltage	V _R M		
Average Rectified Output Current	I _O	10	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	180	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance	R _θ JA	102	°C/W
Thermal Resistance Junction to Ambient (Note 5)			
Thermal Resistance Junction to Ambient (Note 6)			
Operating Temperature Range	T _J	V _R ≤ 80% V _R RM	-65 to +150
		V _R ≤ 50% V _R RM	≤180
		DC Forward Mode	≤200
Storage Temperature Range	T _{STG}	-65 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _(BR) R	45	-	-	V	I _R = 0.5mA
Forward Voltage Drop	V _F	-	0.39	-	V	I _F = 5A, T _J = +25°C
		-	0.46	0.53		I _F = 10A, T _J = +25°C
Leakage Current (Note 7)	I _R	-	-	400	μA	V _R = 45V, T _J = +25°C

- Notes: 5. FR-4 PCB, 2oz. Copper, minimum recommended pad layout per <http://www.diodes.com>.
6. Polyimide PCB, 2oz. Copper, minimum recommended pad layout per <http://www.diodes.com>.
7. Short duration pulse test used to minimize self-heating effect.

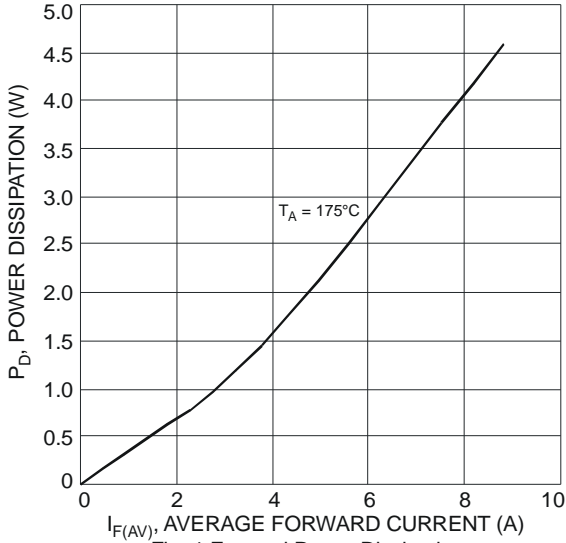


Fig. 1 Forward Power Dissipation

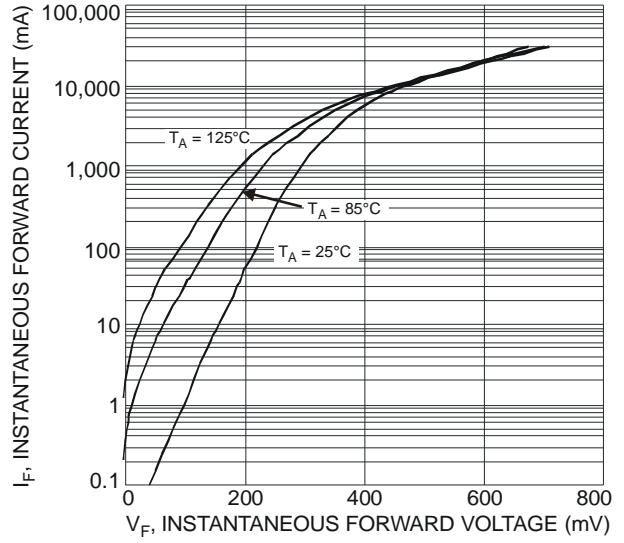


Fig. 2 Typical Forward Characteristics

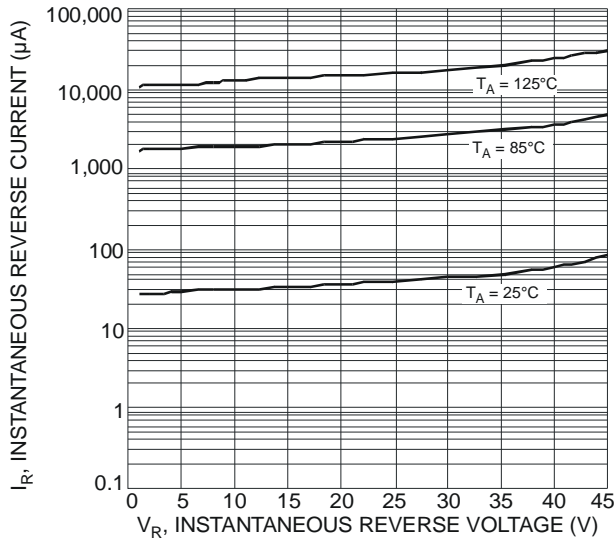


Fig. 3 Typical Reverse Characteristics

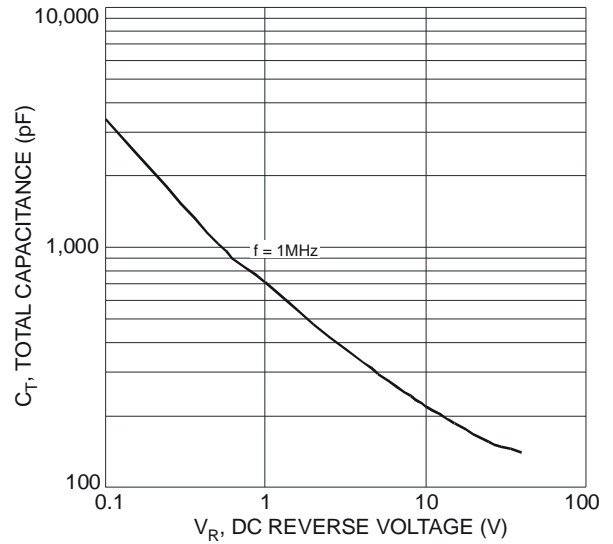


Fig. 4 Total Capacitance vs. Reverse Voltage

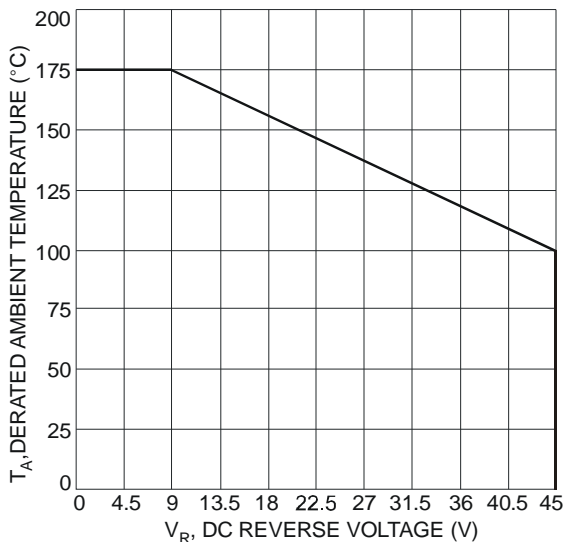


Fig. 5 Operating Temperature Derating

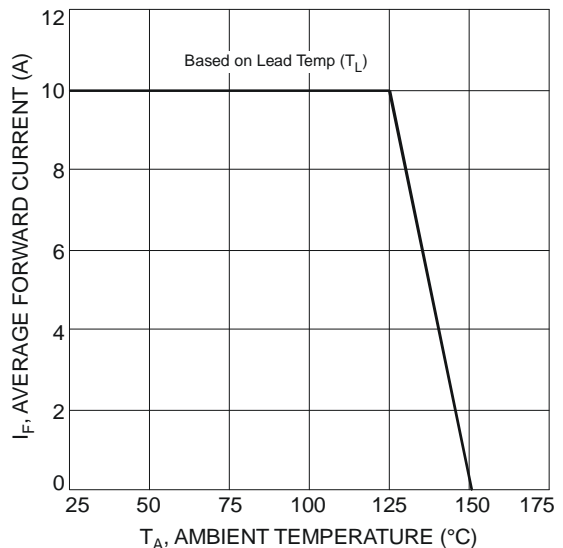
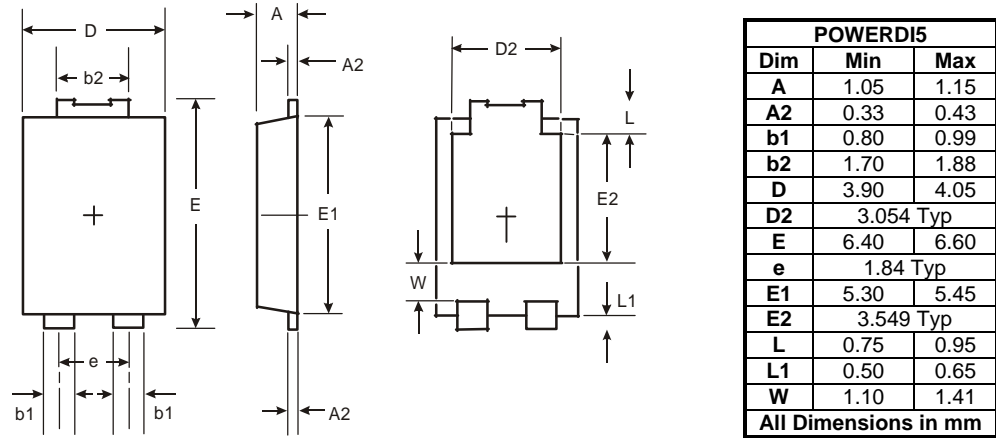


Fig. 6 Forward Current Derating Curve

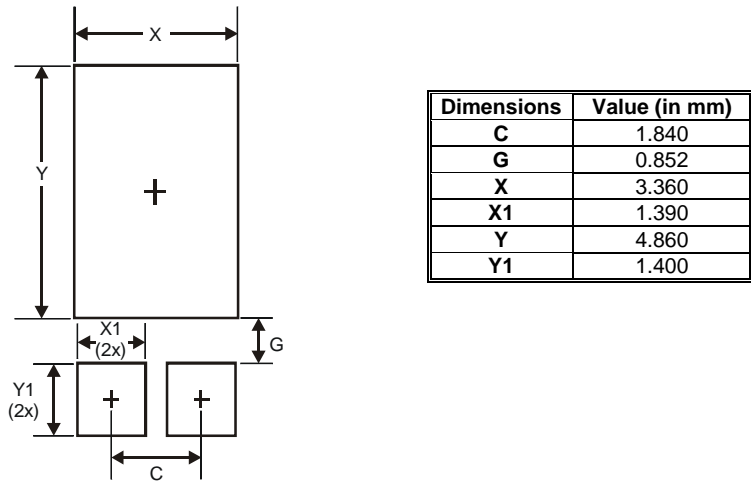
Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



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